

Thermal Pad 21-869

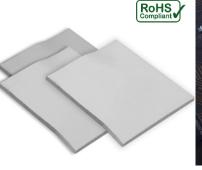
🖺 FEATURES & BENEFITS

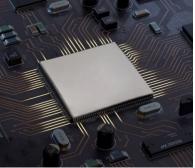
- Thermal Conductivity :7.0W/m·K
- Ultra Soft (Putty Like)
- Extremely Good Thermal Performance
- Excellent Surface Wetting
- High Breakdown Voltage
- Easy For Installation

SAPPLICATIONS

- Memory Modules
- Mass Storage Devices
- Automotive Electronics
- Telecommunication Hardware
- Radios
- Power Electronics
- Set-Top Boxes
- IT Infrastructure

TYPICAL PROPERTIES





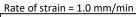
JONES Thermal Pad 21-869 is an ultra soft putty like gap filling material rated at a thermal conductivity of 7.0 W/m-K.It is highly conformable to uneven and rough surfaces, where require the thermal gap filler material has a characteristics of over 50% compressibility.Its soft construction offers high conformability and effectively reduces thermal resistance.

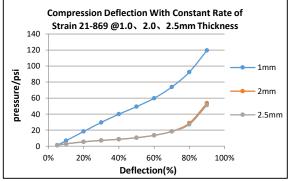
JONES Thermal Pad 21-869 is natually tacky and 21-869A is single-side tacky, both of which facilitate easy handling and simplified application.

| | Properties | Thermal Pad 21-869 | Test Method |
|------------|---------------------------------|-----------------------|-------------------|
| Thermal | Thermal Conductivity (W/m·K) | 7.0 | ASTM D5470 |
| | Operating Temperature Range(°C) | -55~150 | JONES Test Method |
| Physical | Color | Gray pink | Visual |
| | Composition | Ceramic&Silicone | - |
| | Density (g/cm^3) | 3.0 | ASTM D792 |
| | Thickness Range (mm) | 1.0~5.0 | ASTM D374 |
| | Thickness Tolerance(mm)> 1mm | ±10% | |
| | Hardness (Shore 00) | 35 | ASTM D2240 |
| Electrical | Breakdown Voltage (KV AC/mm) | >5 | ASTM D149 |
| | Volume Resistivity (Ohm·cm) | 10^12 | ASTM D257 |
| | Dielectric Constant@1MHz | 6.0 | ASTM D150 |
| Regulatory | Flame Rating | VO | UL 94 |

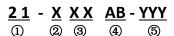
TEST RESULTS

21-869Gap Pad 1.0 mm Thick; 1 inch^2 test sample; Compression Deflection



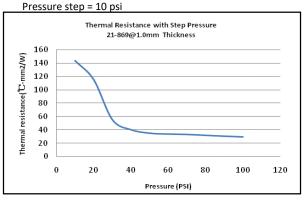


PART NUMBER SYSTEM



- ① 21-Thermal management material
- ② X-Hardness
- ③ XX-Thermal Conductivity
- ④ <u>AB</u>-Optional style
- ④ YYY-Dimension

Thermal Resistance



CRDERING INFORMATION

Recommended Compression

Suitable for wide range of compression.

Standard Size

4" X 8" (100mm X 200mm) Customizable packaging

Storage Requirement

20°C to 25°C, 50%RH

12 months from date of manufacture.

* Unopened Original Package

HANDLING PRECAUTIONS

SAFETY DATA SHEET (SDS).

FOR SAFE HANDLING INFORMATION OF THIS PRODUCT, PLEASE CONTACT WITH YOUR JONES REPRESENTATIVE FOR THE

LIMITED WARRANTY INFORMATION

The information provided in this Technical Data Sheet including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the data of this TDS. Jones Corp is not, therefore, liable for the suitability of any Jones Corp products for any specific or general uses. Jones Corp shall not be liable for incidental or consequential damages of any kind.

FOR MORE INFORMATION

About our high performance materials, solutions and capabilities, please visit our website:

http://www.jones-corp.com

Disclaimer

- The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the issuing date of this TDS. When using our products, no matter what type of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this TDS are subject to change without prior notice.
 Do not use the products beyond the specifications described in this TDS. This TDS explains the typical performance of the products as individual component.
- Do not use the products beyond the specifications described in this IDS. This IDS exp Before use, check and evaluate their operations when installed in your products.
- The product provided in this TDS compliance with HSF.

JONES TECH PLC 3 Dong Huan Zhong Road, BDA,Beijing 100176 China TEL: +86 10 6786 2636 FAX: +86 10 67860291 E-mail: sales@jones-corp.com

